

Circuit Design of Key Components for an Analog-to-Digital Converter in Optical Communications

Integrated Mixed-Signal Circuit Design

Type of Work:

- Practical Work in our CAD Lab
- Design Key Circuit Diagrams
- Implement Schematics with High-Performance SiGe-HBTs
- Verify Designs by Time- and Frequency-Domain Simulations

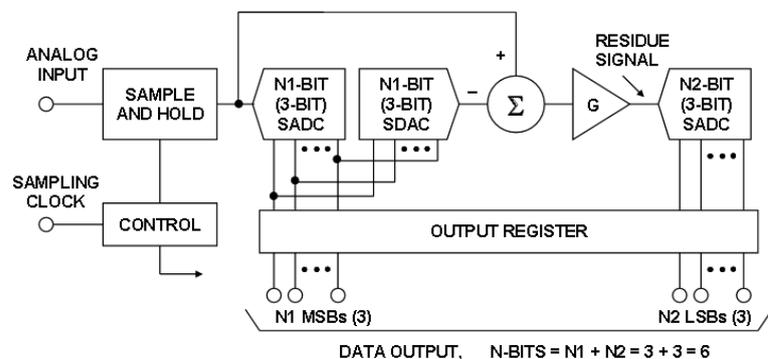
Favored Skills & Interests:

- Experience with Circuit Design & Simulation Tool (best: Cadence Virtuoso)
- Integrated Mixed-Signal Circuits
- Basic Transistor Amplifiers
- Interest in High-Frequency Electronics

Background: Mass use of mobile internet services and cloud computing thrives the need for ultra-high data rate transmission. Therefore, intra- and interconnections of powerful data centers are equipped with optical transmission systems, using the highest bandwidth available. Optoelectronic receivers must convert the optical signal back into a digital, electrical signal to process data. Photodiodes and often heavily parallelized analog-to-digital converters (ADCs) are main components of these optoelectronic receivers.

For a 4-fold ADC parallelization concept, we are designing a 40 Gigasample per second (GS/s) ADC-core with an effective resolution of 6 bits (ENOB), to reach record data transmission rates near 1 Tbit/s!

Description of Work: We combine the high data rate of a flash ADC with the higher resolution of a pipeline concept. In this thesis, you will design key components for both parts in a high-performance SiGe BiCMOS technology that is not yet commercially accessible. A sampling front-end and clock driver is already available.



Additional components include, but are not limited to, comparators, buffer amplifiers and a digital encoder in current-mode logic. You will optimize your design through simulations and gather profound knowledge of time- and frequency-domain analysis. Upon completion of the circuit schematic, it can be tested for robustness with corner and mismatch simulations.

Exemplary Architecture of a 6-bit Pipelined ADC

This work provides insights into the design processes that you find in semiconductor industry or research institutions all over the world and prepares for a career in these areas. The master thesis can be prepared in English or German language.

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